PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JIE GU	06/03/2015
ZHENHUA XU	06/03/2015

RECEIVING PARTY DATA

Name:	JIMHO ROBOT (SHANGHAI) CO., LTD.	
Street Address:	NO. 500 BI BO ROAD, ZHANGJIANG HI-TECH PARK	
Internal Address:	PUDONG	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201203	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14654723

CORRESPONDENCE DATA

Fax Number: (414)978-8650

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Address Line 2: QUARLES & BRADY LLP ATTN: IP DOCKET

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ATTORNEY DOCKET NUMBER: 146964.00003 NAME OF SUBMITTER: THOMAS J. KRUMENACHER SIGNATURE: /Thomas J. Krumenacher/ **DATE SIGNED:** 06/22/2015

Total Attachments: 1

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PATENT REEL: 035877 FRAME: 0120 503360401

ASSIGNMENT

WHEREAS, WE, Jie GU and Zhenhua XU, of Shanghal, China, an application for Letters Patent of the United States entitle was filed as Chinese Patent Application 201210573143.2 on Application PCT/CN2013/084941 filed on October 10, 2013, filed on	d LOWER LIMBS REHABILITATION TRAINING ROBOT, December 25, 2012, and PCT International Patent
therefor, and	· · · · · ·
WHEREAS, <u>JIMHO ROBOT (SHANGHAI)CO.</u> , <u>LTD</u> (hereinafter having a place of business at <u>No.500 Bi Bo Road</u> , <u>Zhangjiang</u> China is desirous of acquiring the entire interest in said inverthe territories thereof, for all other countries and under all in	<u>Hi-Tech Park, Pudong, Shanghai 201203, P.R. China,</u> ntions throughout the United States of America and
NOW, THEREFORE, for and in consideration of One Dollar (\$\text{S}\) consideration, receipt whereof is hereby acknowledged, we successors and assigns, the entire right, title and interest thr territories thereof, for all foreign countries and under all into aforesaid application, all other applications hereafter filed in international agreement based in whole or in part on said in applications by the United States, by any other country or us authorize and request the Commissioner of Patents and Trace We further grant to said Company, its successors and assigns benefits and priority rights of any international agreement becountries or between any other countries.	hereby sell, assign and transfer unto said Company, in roughout the United States of America and the ernational agreements in and to said inventions, the of the United States, in any other country, or under any ventions, and all Letters Patents granted upon said ander any international agreement, and we do hereby demarks to issue said Letters Patent to said Company of the right to claim for any of said applications the for
We hereby warrant that we have the full right to make the cour heirs, legal representatives and assigns, will when reques representatives, successors and assigns, all facts known resp continuing, reissue, reexamination and foreign or internation therefor, make all rightful oaths, sign all lawful papers, testif possible to aid said Company, its successors and assigns, in the company is successors.	sted, communicate to said Company, its ecting said inventions, execute all divisional, nal applications, together with individual assignment y in any legal proceeding and generally do everything
IN TESTIMONY WHEREOF, we have hereunto set our hands a with our signatures. Date:	and seals at the locations and on the dates indicated Jie Gu Fb Be (SEAL)
WITNESS:	
Sign/Date: Enlai Ma BB 2015. 6. Sign/Date: Shuneng Hou 1304 PA 2015.	<i>3</i> .6.3
Date: 7015.6.3	Zhenhua Xu 245764 (SEAL)
WITNESS:	
sign/Date: Znlai Ma S鬼 2015.6,3	
Sign/Date: Znlai Ma SD未 2015.6, 3 Sign/Date: Shunong Hon 13.64节6 >	p15.6.3

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